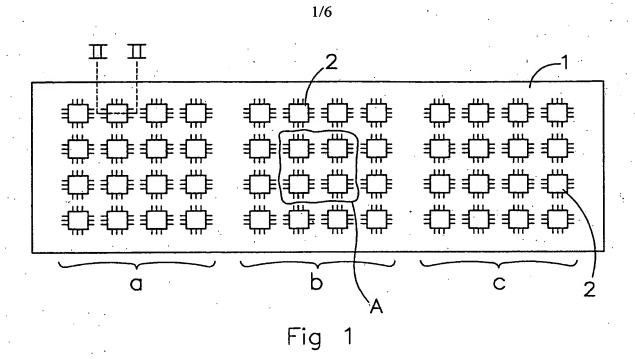
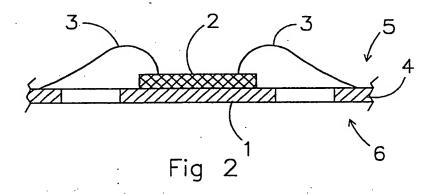
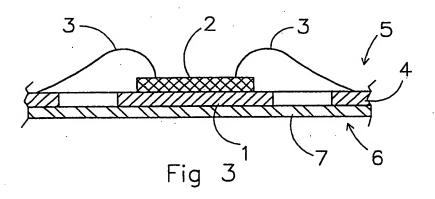
METHOD FOR MANUFACTURING ENCAPSULATED ELECTRONIC COMPONENTS, PARTICULARLY INTEGRATED CIRCUITS Inventors: Janssen et al. Docket No: 903-51 CON

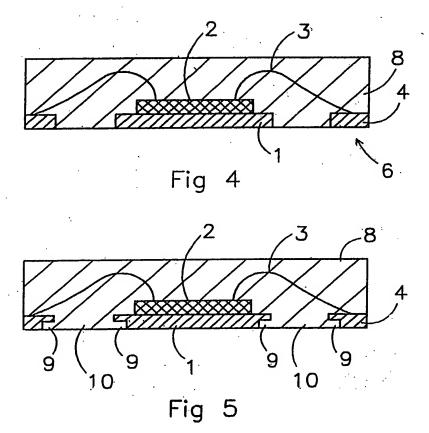






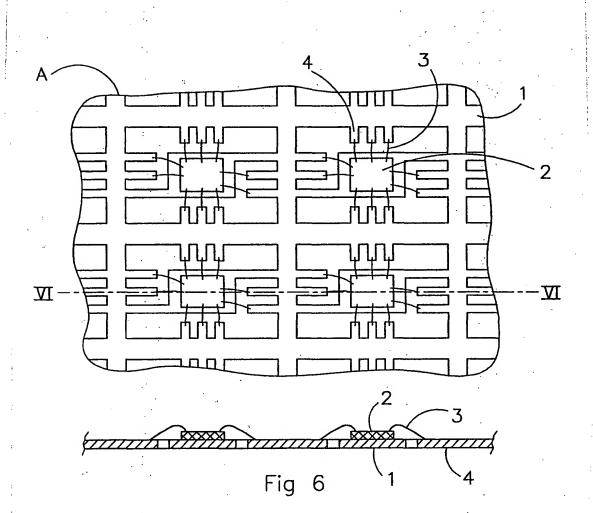
Inventors: Janssen et al.

Docket No: 903-51 CON

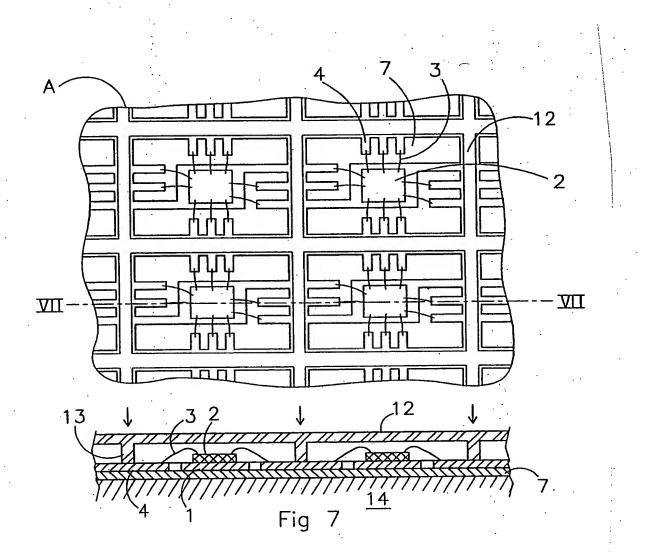


Inventors: Janssen et al.

Docket No: 903-51 CON



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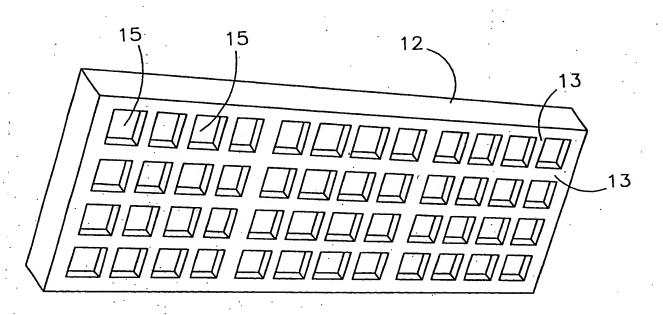


Fig 8

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Docket No: 903-51 CON

